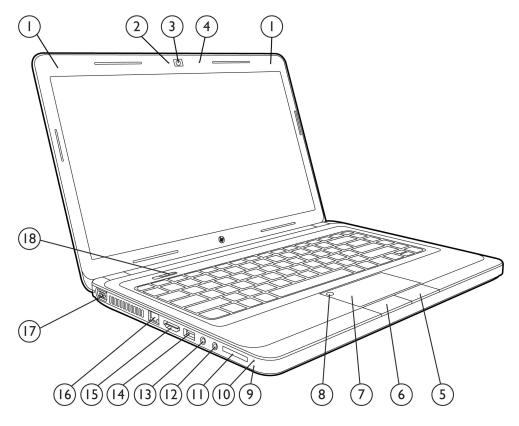
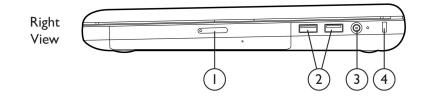
Overview

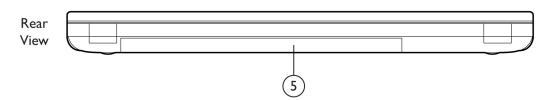


- 1. Two antennas
- 2. Webcam light
- 3. Webcam
- 4. Internal microphone
- 5. Right touchpad button
- 6. Left touchpad button
- 7. Touchpad with scroll zone
- 8. Touchpad light
- 9. Drive light

- 10. Power light
- 11. Digital Media slot
- 12. Audio-out (headphone) jack / Audio-in (microphone) jack
- 13. Audio-in (microphone) jack
- 14. USB port
- 15. HDMI port
- 16. RJ-45 network jack
- 17. External monitor port
- 18. Power button

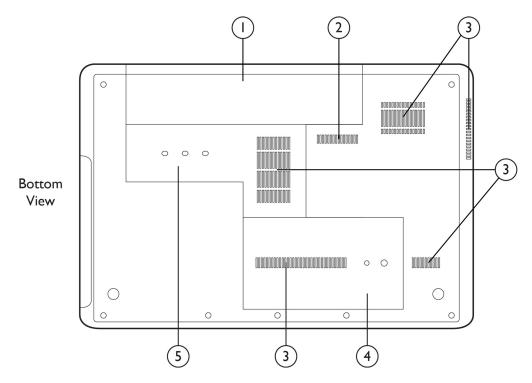
Overview





- 1. Optical drive
- 2. USB ports
- 3. Power connector

- 4. Security cable slot
- 5. Battery bay



- 1. Battery bay
- 2. Battery release latches
- 3. Vents

- 4. Hard Drive Bay
- 5. Memory module compartment



Overview

At A Glance

- Genuine Windows 7 versions, SUSE Linux*
- Intel® HD Graphics family with shared memory
- Durable, sophisticated design with smooth surface pewter color.
- Full-sized keyboard with action keys enabling functions directly
- HDMI port for connecting to high-resolution displays
- Integrated VGA webcam, integrated microphone
- Integrated 802.11 b/g/n wireless LAN module**
- Bluetooth[™] 2.1 or Bluetooth 3.0 + High Speed (HS)**
- Widescreen 15.6-inch diagonal LED-backlit HD display with 16:9 aspect ratio



^{*} Operating system options vary by country.

^{**} Select models only (BT3.0 HS supports under Windows 7 OS only, BT2.1 supports under Linux)

Standard Features (availability may vary by country)

Processors Intel® Pentium® Processor B960 (2.20 GHz, 2 MB L3 Cache)

2nd generation Intel Core i3-2350M processor

(2.3 GHz, 3 MB L3 Cache)

Intel Core i3-380M processor (2.53 GHz, 3 MB Intel® Smart Cache)

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds in

battery optimization mode.

Operating System Preinstalled Genuine Windows 7 Starter 32*

Genuine Windows 7 Professional 64*
Genuine Windows 7 Home Premium 64*
Genuine Windows 7 Home Basic 64*
SUSE Linux Enterprise Desktop 11

* Operating system options vary by country.

Certified SUSE Linux Enterprise Desktop 11

Chipset Mobile Intel® GM45 Express Chipset with ICH9M

Mobile Intel® HM55 Express Chipset Mobile Intel® HM65 Express Chipset

Graphics Models with Mobile Intel GM45 Express Chipset with ICH9M

Integrated: Intel Graphics Media Accelerator 4500MHD

Models with Intel® HM55 Express Chipset

Integrated: Intel® HD Graphics

Models with Intel® HM65 Express Chipset

Integrated: Intel® HD Graphics
Integrated: Intel® HD Graphics 3000

Support for BD and/or HD-DVD playback with HD Decode, and DX10(for Integrated)/DX11 (for Discrete)

Support

Display Internal 15.6-inch diagonal LED-backlit HD 16:9 widescreen Anti-Glare

(1366 x 768 resolution)

External Up to 32-bit per pixel color depth

VGA port supports resolutions up to 2048 x 1536 external resolution @75 Hz **HDMI** 1.3 port supports up to 1080p, 1920x1080 at 60Hz and 1920x1200 @

60Hz DVI Mode

NOTE: Resolutions are dependent upon monitor capability, and resolution and

color depth settings.

Standard Features (availability may vary by country)

Memory

Standard DDR3 SDRAM (800MHz/1066 MHz/1333 MHz)*

Two SODIMM slots supporting dual-channel memory

2048 MB and 4096 MB SODIMMs

MaximumUpgradeable to 8192 MB with optional 4096 MB SODIMMs in slots 1 and 2Dual-channelMaximized dual-channel performance requires SODIMMs of the same size and

speed in both memory slots.

* Maximum memory speed supported by the system may be 800MHz, 1066 MHz or 1333MHz

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. With Windows Starter 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

Communications

Realtek Ethernet Integrated Controller (10/100 or 10/100/1000 NIC)*

- * 10/100 NIC supports Models with Mobile Intel GM45 Express Chipset with ICH9M
- * 10/100/1000 NIC support in rest models

Wireless Devices

Support for a broad range of secure, integrated wireless LAN options featuring support for the latest industry standards. Integrated Bluetooth is also available (factory configurable only) and can be combined with any of the supported wireless LAN options.

All 802.11 integrated

Wi-Fi certified

wireless LAN options

Wired Equivalent Privacy (WEP) support up to 128-bit keys

Wi-Fi Protected Access (WPA) and WPA2 support

802.1x authentication support, including EAP-TLS, EAP-TTLS, PEAP-GTC,

PEAP-MSCHAPv2, and LEAP

Advanced Encryption Standard (AES) support Dual antennas integrated in the display enclosure

HP Integrated Module with Bluetooth Wireless

Bluetooth Specification v3.0 compliant**
Works with a wide range of Bluetooth devices

Technology

- * In countries where 802.11n is not allowed, this capability is not enabled.
- ** BT3.0 is supported in Windows 7 OS only, BT2.1 is supported in Linux

Keyboard

The 100% compatible keyboard features a, industry standard, full-pitch key layout with features such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, and 12 function keys. International key layouts are available. Other features include hotkeys for instant access to, brightness, etc. 19-mm x 19-mm key pitch (center-to-center spacing), 2.2-mm stroke, comfort-dished keycaps, and bright key legends for improved visibility in low light conditions.

Pointing device

Touchpad with 2-piece pick button with left and right click functions

Multi-touch gestures supported

On/off button

Standard Features (availability may vary by country)

Expansion card slots Digital Media slot Supports SD (Secure Digital), and MultiMediaCard

Supports mini versions with adapter

Storage Hard drives 250 GB 7200 rpm SMART SATA II

250/320/500 GB 5400 rpm SMART SATA II

NOTE: Up to 19 GB is reserved for the system recovery software.

DriveGuard The hard drive is mounted directly to the notebook frame, reducing the

transmission of shock to the hard drive.

Fixed optical drives Optional DVD+/- RW Supermulti DL Drive

Interfaces VGA One

HDMI One Stereo Microphone in One Stereo Headphone/line One

out

Power connectorOneRJ-45/EthernetOneUSB 2.0ThreeLED status indicatorsNine

Audio/Visual High Definition Audio support

Integrated microphone

Integrated stereo speaker (Altec Lansing)

Headphone/line out Microphone in

Integrated VGA webcam

- Supports videoconferencing and still image capture
- Improved quality for video streaming and still image capture (640x480 resolution)
- Up to 24 frames/sec
- Fixed focus lens



Standard Features (availability may vary by country)

Software

Preinstalled Software with Windows Operating

System

HP Recovery Manager HP Support Assistant*

Microsoft Office 2010 preloaded (purchase of a Product Key required to activate a full Office 2010 suite)**

HP Wireless Assistant* Cyberlink Power DVD *** Cyberlink YouCam BE****

Symantec Norton™ Internet Security 2011 (60-day trial)

HP Recovery Manager

HP Recovery Manager enables fast recovery of the factory preinstalled image if the system becomes corrupted or if important system files are accidentally deleted. Up to 19 GB of the hard drive is reserved for the system recovery software.

* Support in Windows Operating System only

Security

Standard Features

Setup Password

Kensington Lock

LoJack for Laptops (must be purchased separately)

For more information on HP security solutions refer to: http://www.hp.com/go/security.

Power Supply

External 65-watt smart pin design AC adapter

1.0meter power cord included

Total length including External AC adapter is 12 feet (3.66 meter).

Fast Charge**

*65 watt AC adapter for UMA model/90 watt AC adapter for discrete model

** Fast Charge recharges your battery up to 90% within 90 minutes when the system is off. HP Fast Charge Only for 6 cell/47 WHr battery pack.

Battery

HP 6-cell (47 WHr) Li-Ion battery

Battery Life

Primary 6-cell (47 WHr) battery Up to 5 hours

NOTE: Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark07 battery benchmark http://www.bapco.com/products/mobilemark2007 for additional details.

System Standby Time

1 week*

* For models with Intel® HM55 Express Chipset standby time can only last 5

days



^{*} Please note this is not available in all regions.

^{**} Microsoft Office 2010 Preloaded includes reduced functionality versions of Word and Excel. Purchase of Product Key required to activate full Office 2010 suite available at participating resellers/retailers and http://www.office.com.

^{***} Please note this is available on select models and not available in all regions.

^{****} Available on select models.

Standard Features (availability may vary by country)

Power Conservation Hibernation*

Standby*

ACPI compliance*

* Only OS W7 & Linux will feature power conservation

Service and Support

HP Services offers limited 1-year warranty options depending on country;

1-year limited warranty on primary battery. On-site service and warranty upgrades are also available. HP Care Pack Services extend service contracts beyond the standard warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at:

http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack.

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp



Options (availability may vary by country)

NOTE: Options/capabilities listed in the QuickSpecs represent those capabilities available through Base Units or Build to Order configurations. The various product features and capabilities will vary in terms of configurable vs. aftermarket options (AMOs). There may be options and capabilities available through CTO that are not available as AMOs.

configurations. The various product features and capabilities will vary in terms of configurable vs. aftermarket options (AMOs). There may be options and capabilities available through CTO that are not available as AMOs.		
Other Storage	HP 250 GB USB Pocket Media Hard Drive	XQ543AA
-	HP Mobile USB DVD	XQ543AA
	HP Mobile USB DVDRW	BU516AA
	HP Mobile Blu-ray USB DVDRW	XQ546AA
Expansion	HP USB 2.0 Docking Station	AY052AA#xxx
	HP Essential USB 2.0 Port Replicator	AQ731AA#xxx
	Compaq LAN and USB Travel Hub	BM868AA#xxx
	HP Adjustable Dual Monitor Stand	AW664AA#xxx
	HP Adjustable Display Stand	AW663AA#xxx
	HP Display and Notebook Stand	AW662AA#xxx
	HP Dual Hinge Notebook Stand	AW661AA#xxx
	HP Basic Adjustable Notebook Stand	AL549AA
Power	65W Slim Adapter	AX727AA#XXX
	65W Smart AC Adapter	ED494AA#xxx
	AC Long Power Cord 3-wire (10ft - 3m)	DC851B#xxx
	Primary 6-cell Battery pack	TBD
Carrying Cases	HP Basic Carrying Case	AJ078AA
	HP Basic Backpack	AM863AA
	HP Basic Messenger	AP355AA
	HP Deluxe Roller Case	GD405AA
	HP Deluxe 4 wheel Roller Case	XW576AA
	HP Business Nylon Backpack	BP849AA
	HP Business Nylon Case	BP848AA
	HP Executive Leather Case	RR316AA
	Compaq Top Load Carrying Case	AX338AA
	HP Elite Leather Top Load Case	AX675AA
	HP Elite Leather Messenger	AX676AA
	HP Elite Slim Top Load Case	AX680AA
	HP Professional Slim Top Load Case	AY530AA
	HP Student Edition Youth Backpack w/ rainhood	AY532AA
	HP Professional Series Carrying Case	AT886AA



HP Professional Series Backpack

HP Professional Series Messenger

AT887AA

AT888AA

Options (availability	may vary by country)	_
	HP Professional Series Designer Tote	AT889AA
	HP Merlot Carrying Case	AU095AA#AC3
	HP Professional Series Slip Case	AT890AA
	HP Elite Series Designer Tote	AT891AA
	HP 16.1 Slip Case with Integrated Fan	AY463AA
	HP Professional Series Quick Case	AT892AA
Security	HP Compaq Notebook Combo Lock	AY475AA
	HP Keyed Cable Lock	BV411AA
	HP/Kensington MicroSaver Security Cable Lock	PC766A
Input/Output Devices	HP USB Keyboard & Mouse Bundle	RC465AA#xxx
-	HP USB-P/S2 Optical Mouse	DC369A
	HP USB Optical Travel mouse	RH304AA



Technical Specifications

System Unit Dimensions (HxWxD) 14.80 x 9.72 x 1.25~1.41 (in)

376 x 247 x 31.8~ 35.8 (mm)

Weight Starting at 5.5 lb/2.50 kg

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by

configuration and components. Weight includes 6-cell battery, hard drive,

1 GB memory, and optical drive. Weight varies by configuration and components.

Stand-Alone Power Nominal Operating Voltage 18.5 V

Requirements

(AC Power)

Average Operating Power

Integrated graphics: 14.58 W*

Integrated graphics: 16.10 W**

Integrated graphics: 12.88 W***

* Support models with Intel® GM45 Chipset ** Support Models with Intel® HM55 Express

Chipset

*** Support models with Intel® HM65 Express

Chipset

Max Operating Power < 65 W

Temperature Operating 32° to 95° F (0° to 35° C) (not writing optical)

41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb

temperature

Shock Operating 40 G, 2 ms, half-sine

Non-operating 200 G, 2 ms, half-sine

Random Vibration Operating 0.75 grms

Non-operating 1.50 grms

 Altitude
 Operating
 -50 to 10,000 ft (-15.24 to 3,048 m)

 (unpressurized)
 Non-operating
 -50 to 40,000 ft (-15.24 to 12,192 m)

Industry Standard UL Yes
Certifications CSA Ves

CSA Yes FCC Compliance Yes

ENERGY STAR® Select models*

EPEAT Registered Silver in United States**

ICES Yes Australia / NZ C-Tick Yes

Compliance

CCC Yes

Japan VCCI Compliance Yes
KC Yes
BSMI Yes

CE Marking Compliance Yes

Technical Specifications

BNCI or BELUS Yes CIT Yes GOST Yes Saudi Arabian Compliance Yes (ICCP)

SABS Yes UKRSERTCOMPUTER Yes

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

HP 65W AC Adapter	Dimensions	4.21 x 1.85 x 1.18 in (10.7 x 4.7 x 3.0 cm)
III OSII IIC IIGaptei	D1111C11310113	1.L 1 X 1.03 X 1.10 III (10.7 X 1.7 X 3.0 CIII)

Weight 0.62 lb (280 g) Input 100 to 240 VAC

> Input Efficiency 87% min at 115 VAC

Input frequency range 47 to 63 Hz Input AC current 1.7 A at 90 VAC

Output 65W Output power

DC output 18.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector 3 pin/grounded, mates with interchangeable cords **Environmental Design** Operating temperature 41° to 95° F (5° to 35° C)

-4° to 185° F (-20° to 85° C) Non-operating (storage)

temperature

Altitude 0 to 5,000 ft (0 to 1,524 m)

Humidity 20% to 95% Storage Humidity 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives; Worldwide safety **Certifications**

standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals -C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.

^{*} Configurations of the HP 630 that are ENERGY STAR qualified are identified as HP 630 ENERGY STAR on HP websites and on www.energystar.gov.

^{**} EPEAT registration varies by country. See www.epeat.net for registration status by country. EPEAT status listed above applies to U.S.

Technical Specifications

6-Cell (47 WHr) Lithium-Ion battery **Dimensions** (HxWxL) 0.85 x 2.06 x 8.07 in (2.17 x 5.23 x 20.5 cm) **Weight** 0.7 lb (0.327 kg)

Cells/Type 6-cell Lithium-Ion

Energy Watt-hour Capacity 47 WHr

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C)

Non-operating -4° to 140° F (-20° to 60° C)

Battery Re-Charge Time System in OFF Mode or

Standby

System ON 3 to 5 hours (depending on system power

2.5 hours

consumption)

HP Fast Charge Technology Charges the battery up to 90% within 90 minutes

when system is OFF

Displays

15.6-inch LED HD (1366 x Dimensions (W x H)

768) anti-glare **Dimensions** (W x H) 13.54 x 7.59 in (34.4 x 19.4 cm)

Diagonal Size 15.6 in (39.6cm)

Surface Treatment Anti-glare

Contrast Ratio 400:1 (min)

Refresh Rate 60 Hz

Brightness 210 nit (typical)

Pixel Resolution Pitch 0.252 mm

Format 1366 x 768
Configuration RGB Stripe

Backlight LED PPI 101 ppi

Viewing Angle ±40° Horizontal, ±10°/-30°° Vertical (minimum)

40/40/30/10 (Left/Right/Down/Up)

Internal Storage



Technical Specifications

250 GB 7200 rpm SATA Hard Drive **Drive Weight** 0.25 lbs (115g)

Capacity 250 GB

Height 0.37 in (9.5 mm) or on some models 0.28 in (7 mm)

Width 2.75 in (70 mm)

Interface ATA-8, SATA 2.6, 3.0 Gb/s, NCQ

Transfer Rate Synchronous (maximum) 300 MB/s (Drive Capability)

Seek TimeSingle Track1.5ms(typical reads, including settling)Average11msMaximum22ms

Maximum 22

Rotational Speed 7200 rpm **Logical Blocks** 488,397,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features ATA Security

500 GB 5400 rpm SATA Hard Drive **Drive Weight** 0.22 lb (101 g)

Capacity 500 GB

 Height
 0.37 in (9.5 mm)

 Width
 2.75 in (70 mm)

Interface ATA-8, SATA 2.6, 3.0 Gb/s, NCQ

Transfer Rate Synchronous (maximum) 150 MB/s (Drive Capability)

Seek TimeSingle Track3 ms(typical reads, including
settling)Average13 msMaximum24 ms

Maximum 24

Rotational Speed 5400 rpm **Logical Blocks** 976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features ATA Security

Technical Specifications

320 GB 5400 rpm SATA **Hard Drive**

Drive Weight 0.22 lb (101 q) Capacity 320 GB

Height 0.37 in (9.5 mm) Width 2.75 in (70 mm)

Interface ATA-8, SATA 2.6, 3.0 Gb/s, NCQ

Transfer Rate Synchronous (maximum) 150 MB/s (Drive Capability)

Seek Time Single Track 3 ms (typical reads, including **Average** 13 ms settling) Maximum 24 ms

Rotational Speed 5400 rpm **Logical Blocks** 625,142,448

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features ATA Security

Optical Drives

DVD+/-RW SuperMulti DL Access Times **Drive**

Random

<140ms CD (typical)

< 160 ms DVD (typical)

Max Data Transfer Rate 24X CD-ROM

> **8X DVD** 24X CD-R 24X CD-RW 8X DVD+R 8X DVD+RW 8X DVD-R **6X DVD-RW**

5X DVD-RAM

Transfer Mode UDMA Mode 5 Interface Gen 1 SATA

Supported Media (read) CD-DA, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge

> (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R,

DVD-RW, DVD+R, DVD+RW, DVD-RAM

CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW, DVD-RAM, DVD+R DL, DVD-R **Supported Media** (write)

Max Media Capacity (read) 8.5 GB 8.5 GB **Max Media Capacity**

(write)

Transport Tray Loading



Technical Specifications

Audio

Hardware Implementation Realtek ALC270A-GR High Definition audio

Volume Controls Up, down, and mute function keys

Full DuplexYesMicrophone InStereoHeadphone/Line OutStereoIntegrated MicrophoneYes

Audio Output Quality Frequency Response 10 Hz ~ 30 KHz

Play/Record Sampling

Signal to Noise Ratio>95 dbTotal Harmonic Distortion>83 dBrNoise Floor-110 dB

Rate(s)

Up to 192 KHz

DAC 24 bits
ADC 24 bits

Internal Stereo Speaker Power Rating 1.5 W

Impedance 4 ohms

Communications

Integrated Realtek Eth RTL8165EH-CG 10/100 NIC Integrated Realtek RTL8111E 10/100/1000

NIC

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (100BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 21-30) (

Support in RTL8111E only)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

Power Management ACPI compliant - multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Large send offload and Giant send offload

Receiving Side Scaling

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)



Technical Specifications

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ

NIC Device Driver Name Realtek PCIe FE Ethernet Family Controller

802.11b/g/n WiFi Adapter Wireless LAN Standards IEEE 802.11b

IEEE 802.11g IEEE 802.11n

Interoperability Wi-Fi certified

Cisco Compatible Extensions Program compliant with Microsoft Win7, (details

at: http://www.hp.com/go/notebooks/WLAN)

Frequency Band 2.402 - 2.482 GHz

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: card will support rates for NSS=1 for RX and TX for 20 MHz channels.

Short and long guard intervals shall be supported

Frequency Support 20 MHz: 2.4 GHz bands

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Security¹ Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES,

802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2,

LEAP, EAP-FAST.

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program

Version 5) with Microsoft Windows7only.

Sub-channels Multinational support with frequency bands and channels compliant to local

regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power 13.5 dBm, minimum

Power Consumption Idle associated: 250 mW avg (CLKREQ enabled)

Idle unassociated: 100 mW avg

Transmit/Receive channel: 2.0 /1.6 W

Power Management ACPI compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 72.2 Mbps: -71dBm

Antenna type High efficiency dual antenna with spatial diversity, usually mounted in the

display enclosure

Form Factor PCI-Express Half-MiniCard



Technical Specifications

Weight 4 g

Dimensions 3.3 x 26.65 x 29.85 mm

Operating Voltage 3.3v +/- 9%

Temperature Operating -10° to 70° C

Non-operating -40° to 80° C

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity Amber LED on-Radio OFF; White LED on-Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

4. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista and Win7.

802.11b/g/n Bluetooth 3.0 Combo Card

Wireless LAN Standards IEEE 802.11b

IEEE 802.11g IEEE 802.11n

Interoperability Wi-Fi certified

Cisco Compatible Extensions Program compliant with Microsoft Windows7

(details at: http://www.hp.com/go/notebooks/WLAN)

Frequency Band 2.402 – 2.482 GHz

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: card will support rates for NSS=1 for RX and TX for 20 MHz channels.

Short and long guard intervals shall be supported

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Security Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES,

802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2,

LEAP, EAP-FAST. WAPI

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program

Version 5) with Microsoft Windows Vista and XP only.

Sub-channels Multinational support with frequency bands and channels compliant to local

regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points



Technical Specifications

Output Power (for CCK)² 13.5dBm , minimum

Power Consumption Idle associated: 250 mW
Idle unassociated: 150 mW

Transmit: 2.0 W (max) Receive: 2.0 W (max)

Power Management ACPI compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 54 Mbps: -62 dBm, 11 Mbps: -82 dBm, 1 Mbps: -89 dBm

Antenna type High efficiency dual antenna with spatial diversity, mounted in the display

enclosure

Form Factor PCI-Express Half-MiniCard

Weight 6 g

Dimensions 3.3 x 26.65 x 29.85 mm

Operating Voltage 3.3v +/- 10%

Temperature Operating 14° to 149° F (-10° to 65° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Off – Radio OFF; Solid LED On – RadioON

*BT 3.0 can only be supported in Windows 7 OS, BT2,1 will be supported in Linux

Bluetooth Specification V3.0 High Speed, V2.1+EDR, backwards compatible with V1.1, 1.2 and 2.0

Number of Available

Channels

79 (1 MHz) available channels

Data Rates and 3 Mbps data rate; throughput up to 2.17 Mbps

Throughput Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or

1306.9 kbps symmetric

Transmit Power -6 dBm to 4 dBm (Bluetooth Class II)

Receiver Sensitivity Better than -80 dBM at 0.1 % raw bit error rate

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW Sleep <17 mW

Antenna Internally integrated within module

Range Up to 33 ft (10 m)
Electrical Interface USB 2.0 compliant

Microsoft Windows Plug and Play compliant

Bluetooth Software

Supported

Broadcom Bluetooth for Windows
Microsoft Windows Bluetooth Software

Link Topology Point to Point, Multipoint Pico Nets up to 7 slaves



Technical Specifications

Security Full support of Bluetooth Security Provisions **Power Management** Microsoft Windows ACPI, and USB Bus Support

Self configurable to optimize power conservation in all operating modes,

including Standby, Hold, Park, and Sniff

Certifications All necessary regulatory approvals for supported countries, including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles

Generic Access Profile (GAP) Supported

Service Discovery Application Profile (SDAP)

Serial Port Profile (SPP)

Dial_Up Networking Profile (DUN) Generic Object Exchange Profile (GOEP)

Object Push Profile (OPP) File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID)

Generic Audio/Video Distribution Profile (GAVDP) Advanced Audio/Video Distribution Profile (A2DP)

FAX Profile (FAX)

Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP) Basic Printing Profile (BPP) VDP (Video Distribution Profile)

AVRCP (Audio Video Remote Control Profile)

Environmental Data

Eco-Label Certifications

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US Energy Star
- IT ECO declaration
- EPEAT Silver where HP registers commercial notebook products. See http://www.epeat.net for registration status in your country.

System Configuration

The configurations used for the Energy Consumption and Declared Noise Emissions data for HP 630 Notebook PC are based on a "Typically Configured Notebook"

Technical Specifications

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	11.28 W	11.61 W	11.30 W
Sleep (Energy Star low power mode)	1.07 W	1.24 W	1.09 W
Off	0.67 W	0.83 W	0.65 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	38.5 BTU/hr	40 BTU/hr	39 BTU/hr
Sleep	4 BTU/hr	4.2 BTU/hr	4 BTU/hr
Off	2.2 BTU/hr	3 BTU/hr	2.2 BTU/hr

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power	Sound Pressure
	(LWAd, bels)	(LpAm, decibels)
Idle	2.8	22
Fixed Disk	4	33
(random writes)		

The system fan will be on by power consumption

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight

The battery type and chemistry used in the product is:

CR2032 (coin cell), Li-ion

6-cell high capacity Lithium-Ion battery (optional 8 cell available)

Additional information

This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2002/95/EC.

This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.

This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level, see www.epeat.net

Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

This product contains 0% post consumer recycled plastic (by wt.)

This product is greater than 96.1% recycle-able when properly disposed of at end of life.

Technical Specifications

Packaging Materials

- External:
 - Corrugated 185 g
 - Corrugated Carton 415 g
- Internal:
 - Polyethylene low density 22 g
 - Molded pulp 100 q
- The Corrugated carton packaging material is made from 80% recycled content.
- The Corrugated packaging material is made from 80% recycled content.
- The Polyethylene low density packaging material is made from 80% recycled content.
- The Molded Pulp packaging material is made from 80% recycled content.

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment

(http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Ozone Depleting Substances



Technical Specifications

- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
- Nickel finishes that release greater than 0.5 µgrams/cm2/week, measured according to EN 1811:1998, are not used on any product surface designed to be frequently handled or touched by users.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard For more information abo Corporate Environmental Information http://www.hp.com/hpinf

For more information about HP's commitment to the environment:

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Environment website

http://www.hp.com/environment

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/

productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/

operations/envmanagement.html

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